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From Jörn Kruse
Dept. DESTO/GP
Phone +49 6221 701-685
Fax +49 6221 701-724
E-mail joern.kruse@de.abb.com

Environmental Information

The purpose of this document is to provide environmental information requested in the procedure for Industrial ^{IT} Enabled level 0.

Product name	HS/S 4.2.1 Outside Light Sensor Interface, MDRC
ABB Identity number	2CDG120044R0011
Information provided by (Name and e-mail address)	Jörn Kruse joern.kruse@de.abb.com
Business Unit	LPED
Date	2013 06 14

1. Related documents

Industrial ^{IT} Architecture - Introduction and Definitions, 3BSE023904

Industrial ^{IT} Certification Overview, 3BSE023905

Industrial ^{IT} Certification Guideline, 3BSE024526

Industrial ^{IT} Enabled Level 0 - Information, Introduction and Definitions, 3BSE025934

Ref documents:

[http://inside.abb.com/The_Insider/Featured_Portals/Industrial IT Deployment/06 Product Certification/Document Library](http://inside.abb.com/The_Insider/Featured_Portals/Industrial_IT_Deployment/06_Product_Certification/Document_Library)

2. Environmental Information

2.1 Content of hazardous materials

Declare the presence of hazardous materials in the product. Printed circuit boards are declared separately under 2.1.1 and should be excluded from the declaration in the table below.

Material	Example application	Yes	No	Quantity/unit <i>Optional ⁽¹⁾</i>
Lead	Batteries, cables, solder		✓	
Cadmium	Batteries, switches, additive in lead		✓	
Mercury	Batteries, switches		✓	
Beryllium	Contact springs		✓	
Brominated flame retardants, e.g: PBB, PBDE, TBBPA	Additive in plastics or rubber		✓	
HCFCs, e.g: R 22, R 123, R 141b	Cooling media		✓	
SF6, sulphurhexafluoride	Breakers		✓	
Polyvinyl chloride, PVC	Cables		✓	

(1) Strive to declare the quantity. This is optional, however, since it is today sometimes difficult to retrieve such information, especially regarding supplied components.

2.1.1 Printed circuit boards

Specify the amount of printed circuit boards used in the product by declaring the total board surface:

- ☒ < 1 dm²
- ☐ 1-10 dm²
- ☐ > 10 dm²
- ☐ No printed circuit boards used in the product

2.2 Recycling information

Is recycling information for the product available?

☐ Yes Ref. Document:.....

✓ No

If No, please specify, in the table below, the component/part/physical position where the material is present:

Material	Component/part/physical position
Lead	None
Cadmium	None
Mercury	None
Beryllium	None
Brominated flame retardants	None
HCFCs	None
SF6, sulphurhexafluoride	None
Polyvinyl chloride, PVC	None

2.3 Energy use and/or losses during the operation of the product

Is energy use and/or losses during operation of the product specified in the product documentation?

☐ Yes Ref. Document : Technical data sheet

☐ No

☒ Not relevant